



Vincotech

flowPIM 0 + PFC		600 V / 20 A
Features		flow 0 17 mm housing
<ul style="list-style-type: none">• Clip in PCB mounting• Trench Fieldstop IGBTs for low saturation losses• Latest generation superjunction MOSFET for PFC		
Target applications		Schematic
<ul style="list-style-type: none">• Embedded Drives• Industrial Drives		
Types		
<ul style="list-style-type: none">• 10-F006PPA020SB03-M685B09		



10-F006PPA020SB03-M685B09

datasheet

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Maximum Ratings

$T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Inverter Switch				
Collector-emitter voltage	V_{CES}		600	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	26	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	60	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	56	W
Gate-emitter voltage	V_{GES}		± 20	V
Short circuit ratings	t_{SC}	$V_{GE} = 15\text{ V}$, $V_{CC} = 360\text{ V}$ $T_j = 150^\circ\text{C}$	6	μs
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$

Inverter Diode

Peak repetitive reverse voltage	V_{RRM}		600	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	32	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	60	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	52	W
Maximum junction temperature	T_{jmax}		175	$^\circ\text{C}$



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Maximum Ratings

$T_j = 25^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
PFC Switch				
Drain-source voltage	V_{DSS}		600	V
Drain current (DC current)	I_D	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	23	A
Peak drain current	I_{DM}	t_p limited by T_{jmax}	151	A
Avalanche energy, single pulse	E_{AS}	$V_{DD} = 50\text{ V}$ $I_D = 0\text{ A}$	159	mJ
Avalanche energy, repetitive	E_{AR}	$V_{DD} = 50\text{ V}$ $I_D = 0\text{ A}$	0,8	mJ
MOSFET dv/dt ruggedness	dv/dt	$V_{DS} = 0..400\text{ V}$ $T_s = 25^\circ\text{C}$	80	V/ns
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	67	W
Gate-source voltage	V_{GSS}		± 20	V
Reverse diode dv/dt	dv/dt		50	V/ns
Maximum Junction Temperature	T_{jmax}		150	°C

PFC Diode

Peak repetitive reverse voltage	V_{RRM}		600	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	43	A
Surge (non-repetitive) forward current	I_{FSM}	$T_j = 25^\circ\text{C}$	180	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	59	W
Maximum junction temperature	T_{jmax}		175	°C

Rectifier Diode

Peak repetitive reverse voltage	V_{RRM}		1600	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	38	A
Surge (non-repetitive) forward current	I_{FSM}	$T_j = 150^\circ\text{C}$	200	A
Surge current capability	I^2t	$t_p = 10\text{ ms}$	200	A ² s
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80^\circ\text{C}$	46	W
Maximum junction temperature	T_{jmax}		150	°C



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Maximum Ratings

$T_j = 25 \text{ }^\circ\text{C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
PFC Shunt				
DC current	I	$T_c = 70 \text{ }^\circ\text{C}$	22	A
Power dissipation	P_{tot}	$T_c = 70 \text{ }^\circ\text{C}$	5	W
Operation Temperature	T_{op}		-55 ... 170	$^\circ\text{C}$
Capacitor (PFC)				
Maximum DC voltage	V_{MAX}		500	V
Operation Temperature	T_{op}		-55 ... 125	$^\circ\text{C}$

Module Properties

Thermal Properties				
Storage temperature	T_{stg}		-40...+125	$^\circ\text{C}$
Operation temperature under switching condition	T_{jop}		-40...+($T_{jmax} - 25$)	$^\circ\text{C}$
Isolation Properties				
Isolation voltage	V_{isol}	DC Test Voltage* $t_p = 2 \text{ s}$	6000	V
Isolation voltage	V_{isol}	AC Voltage $t_p = 1 \text{ min}$	2500	V
Creepage distance			>12,7	mm
Clearance			>12,7	mm
Comparative Tracking Index	CTI		≥ 200	

*100 % tested in production



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max		

Inverter Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,00029	25	5	5,8	6,5	V
Collector-emitter saturation voltage	V_{CEsat}		15		20	25 125	1,1	1,55 1,75	1,9 ⁽¹⁾	V
Collector-emitter cut-off current	I_{CES}		0	600		25			1,1	µA
Gate-emitter leakage current	I_{GES}		20	0		25			300	nA
Internal gate resistance	r_g							None		Ω
Input capacitance	C_{ies}	$f = 1 \text{ MHz}$	0	25	25	25	1100		pF	
Output capacitance	C_{oes}									
Reverse transfer capacitance	C_{res}									
Gate charge	Q_g	$V_{CC} = 480 \text{ V}$	0/15		20	25		120		nC

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{\text{paste}} = 3,4 \text{ W/mK}$ (PSX)						1,7		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 16 \Omega$ $R_{goff} = 16 \Omega$	± 15	400	15	25 125		65,6 65,2		ns
Rise time	t_r					25 125		19,8 21		ns
Turn-off delay time	$t_{d(off)}$					25 125		141,8 167		ns
Fall time	t_f					25 125		76,33 86,36		ns
Turn-on energy (per pulse)	E_{on}					25 125		0,45 0,667		mWs
Turn-off energy (per pulse)	E_{off}					25 125		0,385 0,523		mWs



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Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	T_j [°C]	Min	Typ	Max	

Inverter Diode

Static

Forward voltage	V_F				30	25 125	1,25	1,65 1,61	1,95 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 600$ V			25			27	μ A	

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,81		K/W
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Dynamic

Peak recovery current	I_{RRM}	$di/dt=731$ A/ μ s $di/dt=708$ A/ μ s	± 15	400	15	25 125		10,06 13,55		A
Reverse recovery time	t_{rr}					25 125		173,99 233,08		ns
Recovered charge	Q_r					25 125		0,883 1,79		μ C
Reverse recovered energy	E_{rec}					25 125		0,236 0,474		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 125		36,18 85,35		A/ μ s



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Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	I_D [A]	T_j [°C]	Min	Typ	Max

PFC Switch

Static

Drain-source on-state resistance	$r_{DS(on)}$		10		15,9	25 125		63 115	60 ⁽¹⁾	mΩ
Gate-source threshold voltage	$V_{GS(th)}$		0		0,0008	25	3	3,5	4	V
Gate to Source Leakage Current	I_{GSS}		20	0		25			100	nA
Zero Gate Voltage Drain Current	I_{DSS}		0	600		25			1	µA
Internal gate resistance	r_g							2,8		Ω
Gate charge	Q_g		0/10	400	15,9	25		67		nC
Short-circuit input capacitance	C_{iss}	$f = 250$ kHz	0	400	0	25		2895		pF
Short-circuit output capacitance	C_{oss}							48		

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,05		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 4 \Omega$ $R_{goff} = 4 \Omega$	0/10	400	20	25 125		20,66 19,66		ns
Rise time	t_r					25 125		5,52 6,02		ns
Turn-off delay time	$t_{d(off)}$					25 125		72,75 81,2		ns
Fall time	t_f					25 125		1,38 2,18		ns
Turn-on energy (per pulse)	E_{on}					25 125		0,087 0,229		mWs
Turn-off energy (per pulse)	E_{off}					25 125		0,052 0,063		mWs



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Characteristic Values

Parameter	Symbol	Conditions						Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	I_D [A]	T_j [°C]	Min	Typ	Max

PFC Diode

Static

Forward voltage	V_F				30	25 125 150		1,76 1,39 1,31	2,65 ⁽¹⁾ 1,8 ⁽¹⁾	V
Reverse leakage current	I_R	$V_F = 600$ V				25 150		0,02 50	30 300	μA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,61		K/W
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Dynamic

Peak recovery current	I_{RRM}	$di/dt=3939$ A/μs $di/dt=3830$ A/μs	0/10	400	20	25 125		50,16 64,72		A
Reverse recovery time	t_{rr}					25 125		21,86 29,63		ns
Recovered charge	Q_r					25 125		0,58 1,19		μC
Reverse recovered energy	E_{rec}					25 125		0,203 0,341		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 125		28158,38 2947,25		A/μs



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	I_C [A]	T_j [°C]	Min	Typ	Max	

Rectifier Diode

Static

Forward voltage	V_F				18	25 125 150		1,06 0,994 0,973	1,5 ⁽¹⁾	V
Reverse leakage current	I_R	$V_r = 1600$ V				25 150			100 1000	μA

Thermal

Thermal resistance junction to sink ⁽²⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,54		K/W
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PFC Shunt

Static

Resistance	R							10		mΩ
Tolerance							-1		1	%
Temperature coefficient	t_c								30	ppm/K

Capacitor (PFC)

Static

Capacitance	C	DC bias voltage = 0 V				25		100		nF
Tolerance							-10		10	%
Dissipation factor		$f = 1$ kHz				25		2,5		%



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
		V_{GE} [V]	V_{GS} [V]	V_{CE} [V]	V_{DS} [V]	I_C [A]	T_j [°C]	Min	Typ	Max

Thermistor

Static

Rated resistance	R					25		22		kΩ
Deviation of R_{100}	$A_{R/R}$	$R_{100} = 1484 \Omega$				100	-5		5	%
Power dissipation	P					25		130		mW
Power dissipation constant	d					25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. ±1 %						3962		K
B-value	$B_{(25/100)}$	Tol. ±1 %						4000		K
Vincotech Thermistor Reference									I	

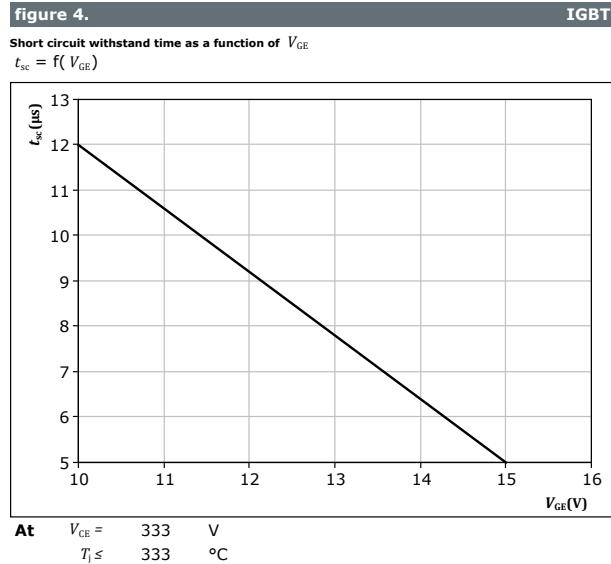
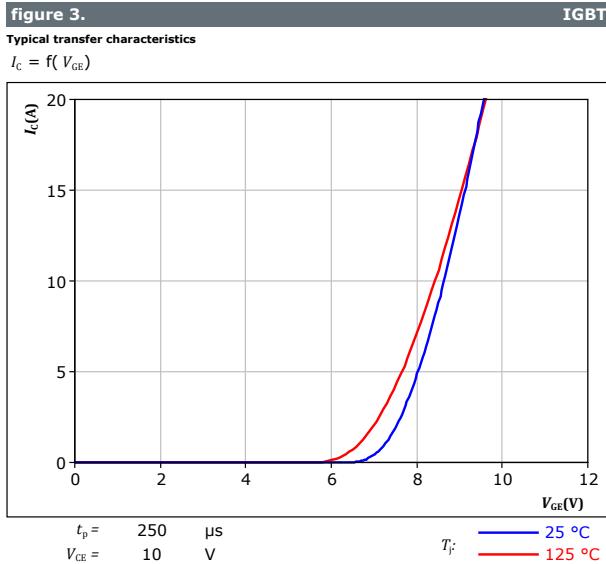
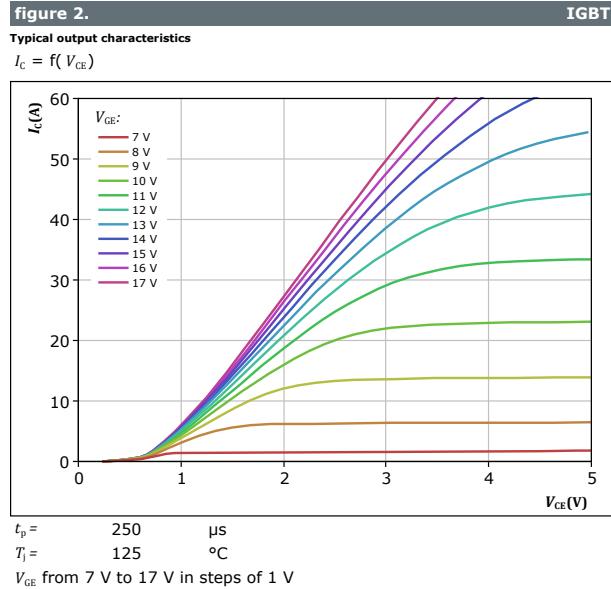
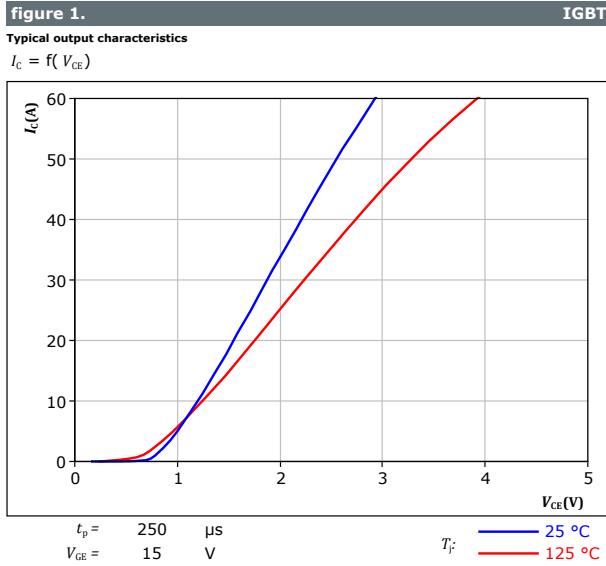
(¹) Value at chip level

(²) Only valid with pre-applied Vincotech thermal interface material.



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Inverter Switch Characteristics



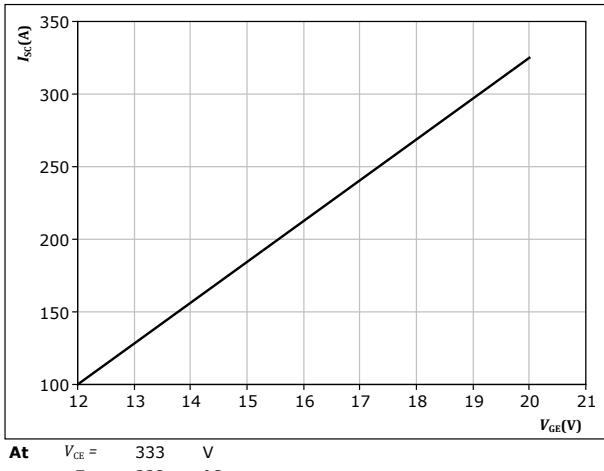


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Inverter Switch Characteristics

figure 5.

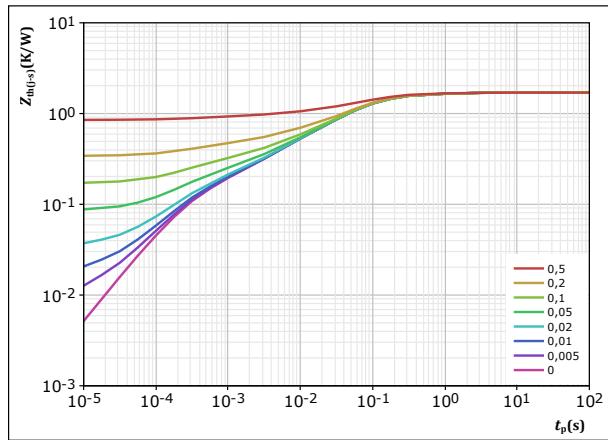
Typical short circuit current as a function of V_{GE}
 $I_{SC} = f(V_{GE})$



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figure 6.

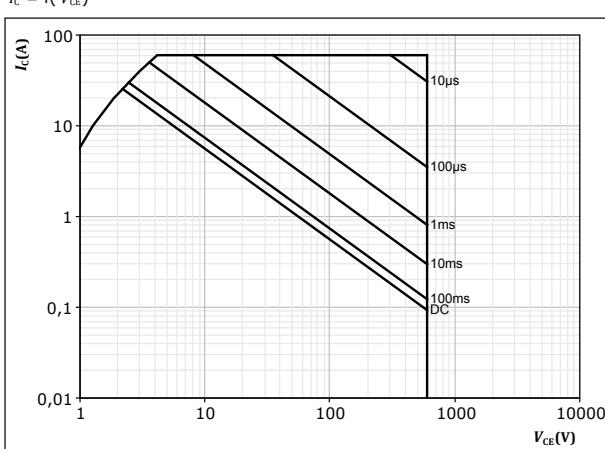
Transient thermal impedance as a function of pulse width
 $Z_{th(j-s)} = f(t_p)$



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figure 7.

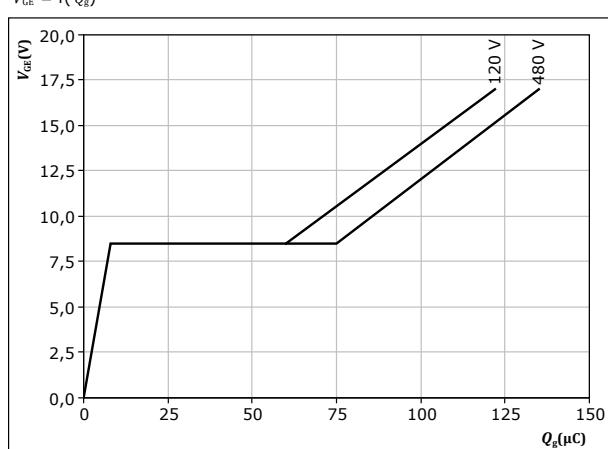
Safe operating area
 $I_C = f(V_{CE})$



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figure 8.

Gate voltage vs gate charge
 $V_{GE} = f(Q_g)$



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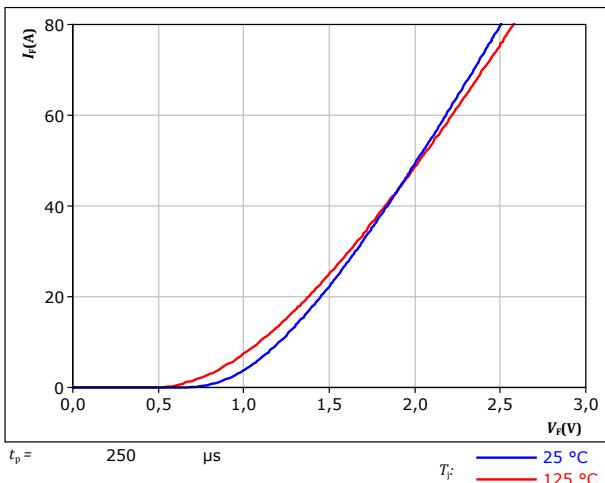


Inverter Diode Characteristics

figure 9.

Typical forward characteristics

$$I_F = f(V_F)$$

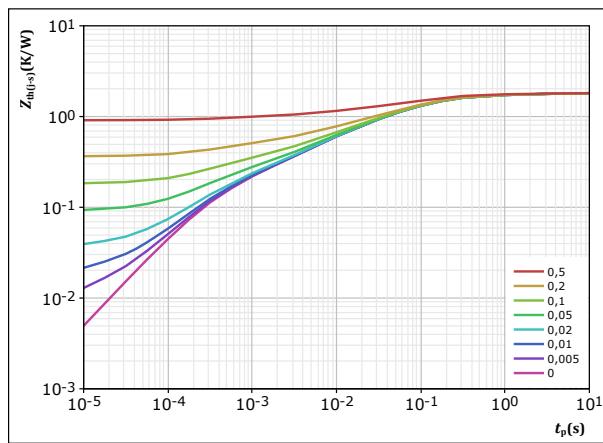


FWD

figure 10.

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$

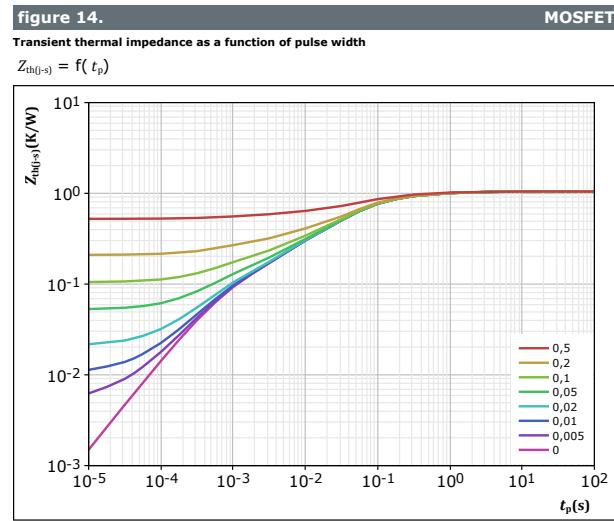
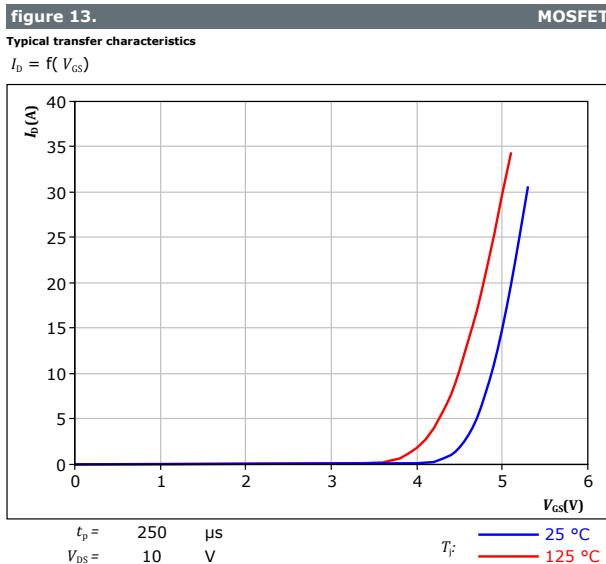
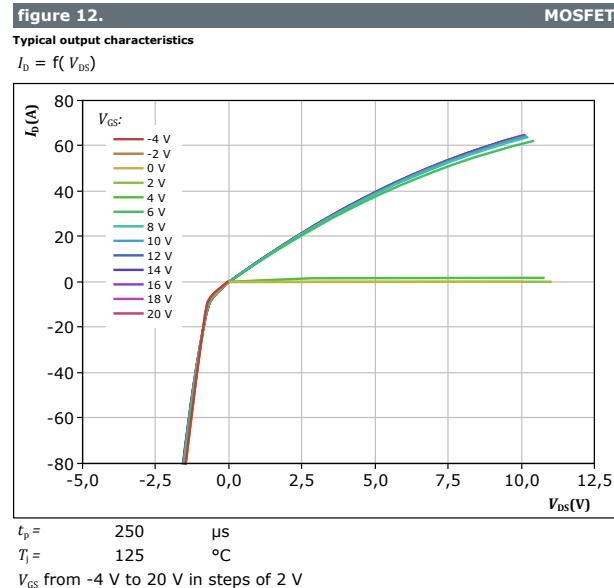
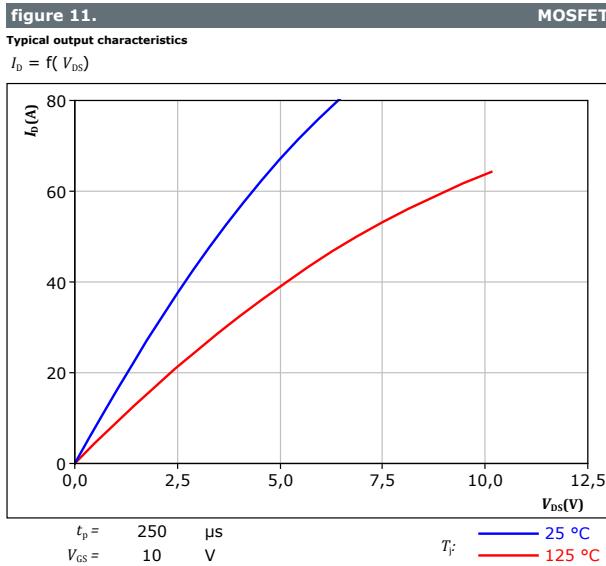


FWD



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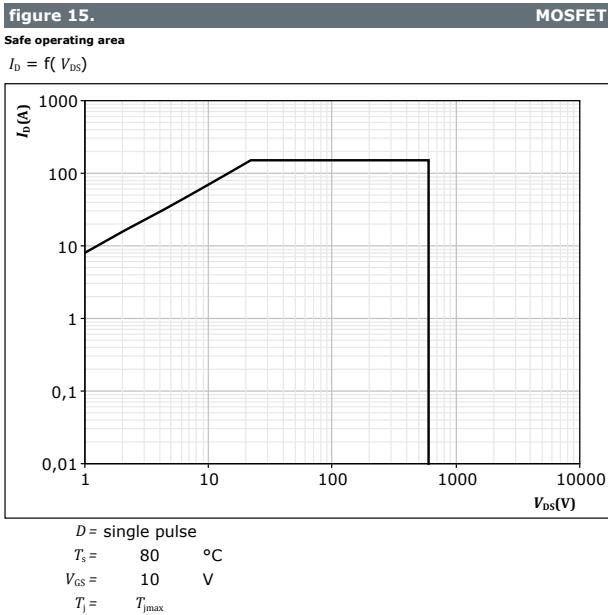
PFC Switch Characteristics



MOSFET thermal model values	
R (K/W)	τ (s)
6,31E-02	1,89E+00
2,11E-01	2,50E-01
5,41E-01	5,16E-02
1,55E-01	6,52E-03
7,68E-02	6,66E-04

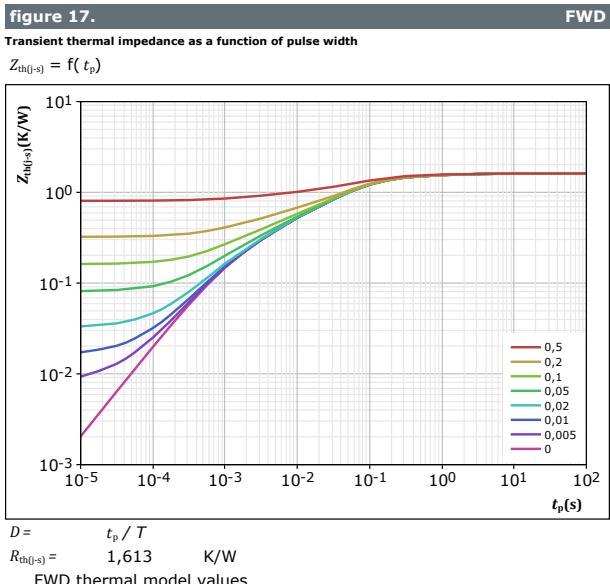
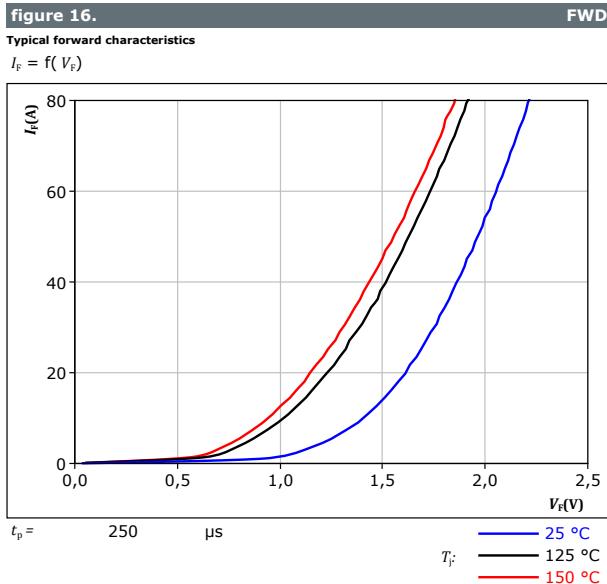


PFC Switch Characteristics





PFC Diode Characteristics





Rectifier Diode Characteristics

figure 18.

Typical forward characteristics

$$I_F = f(V_F)$$

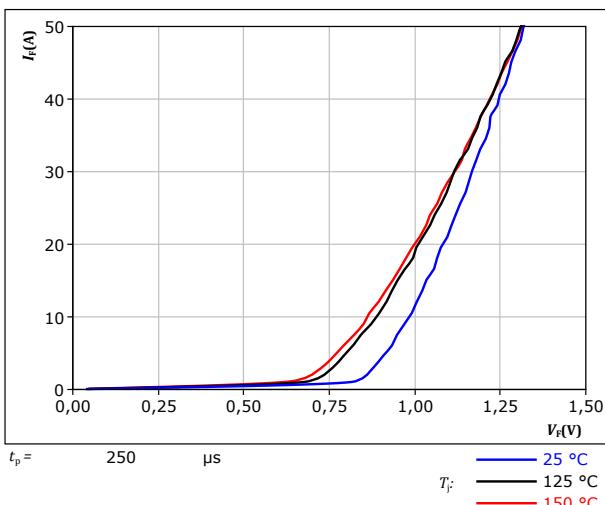
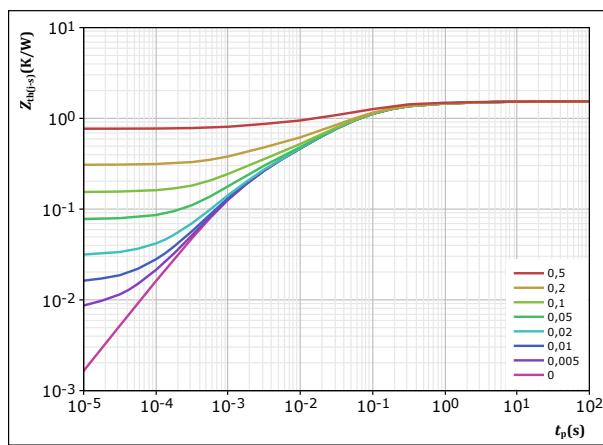


figure 19.

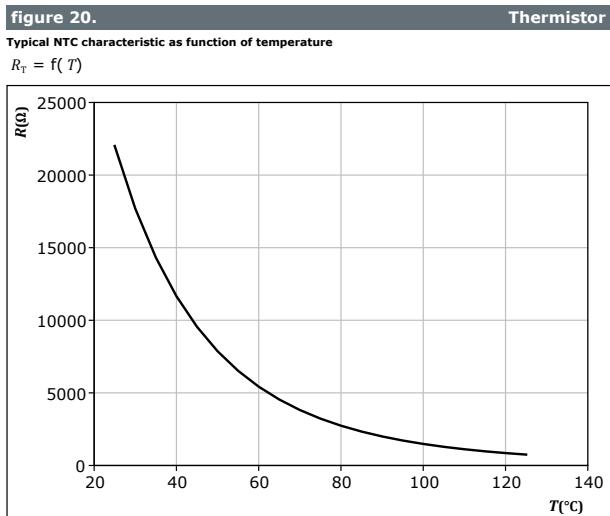
Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$





Thermistor Characteristics





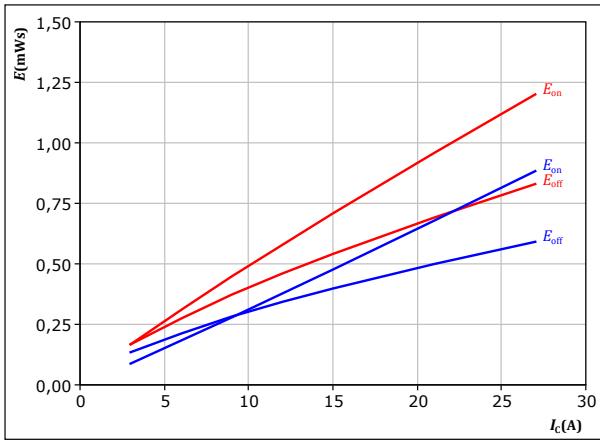
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Inverter Switching Characteristics

figure 21.

Typical switching energy losses as a function of collector current

$$E = f(I_c)$$



With an inductive load at

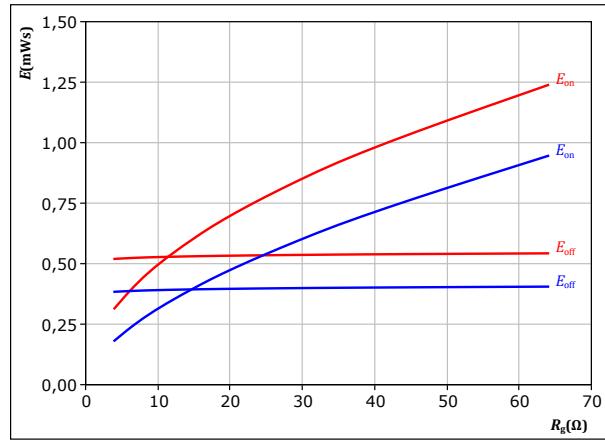
$$\begin{aligned} V_{CE} &= 400 \quad V \\ V_{GE} &= \pm 15 \quad V \\ R_{gon} &= 16 \quad \Omega \\ R_{goff} &= 16 \quad \Omega \end{aligned}$$

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figure 22.

Typical switching energy losses as a function of gate resistor

$$E = f(R_g)$$



With an inductive load at

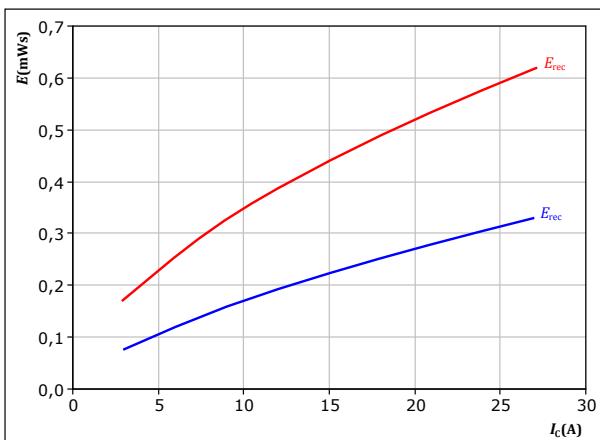
$$\begin{aligned} V_{CE} &= 400 \quad V \\ V_{GE} &= \pm 15 \quad V \\ I_c &= 15 \quad A \end{aligned}$$

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figure 23.

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_c)$$



With an inductive load at

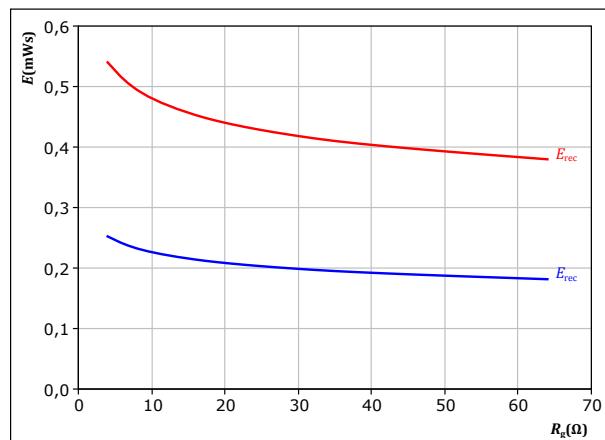
$$\begin{aligned} V_{CE} &= 400 \quad V \\ V_{GE} &= \pm 15 \quad V \\ R_{gon} &= 16 \quad \Omega \end{aligned}$$

FWD

figure 24.

Typical reverse recovered energy loss as a function of gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 400 \quad V \\ V_{GE} &= \pm 15 \quad V \\ I_c &= 15 \quad A \end{aligned}$$

FWD



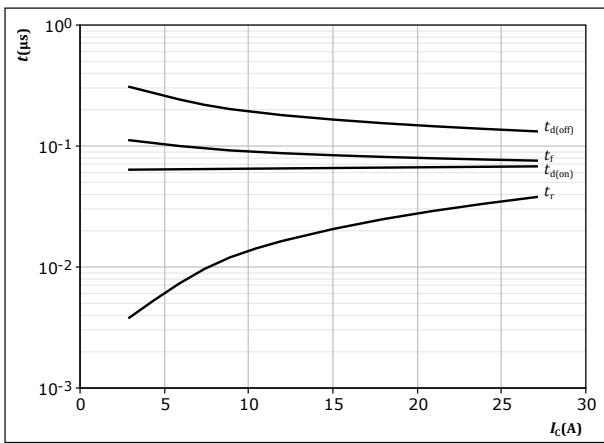
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Inverter Switching Characteristics

figure 25.

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Typical switching times as a function of collector current
 $t = f(I_C)$



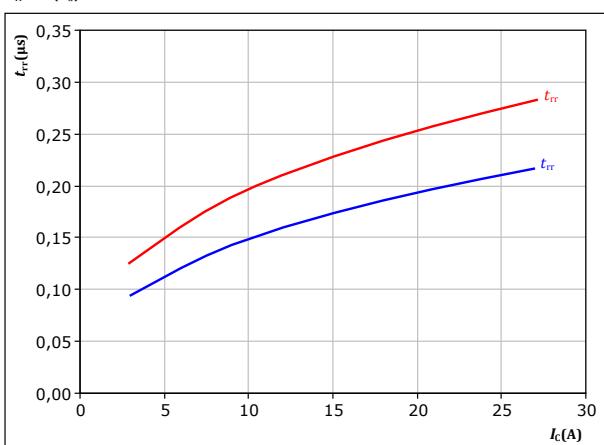
With an inductive load at

$T_j =$	125	°C
$V_{CE} =$	400	V
$V_{GE} =$	±15	V
$R_{gon} =$	16	Ω
$R_{goff} =$	16	Ω

figure 27.

FWD

Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_C)$



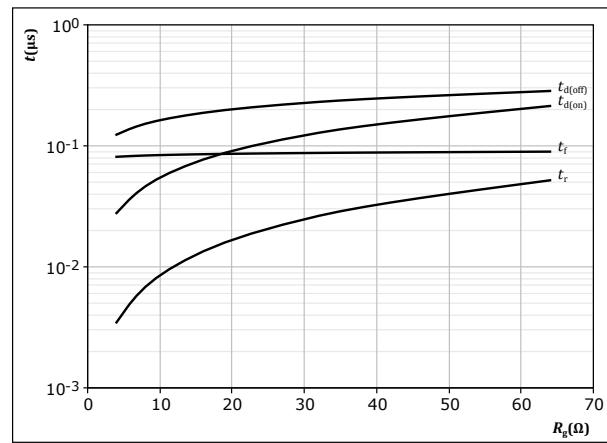
With an inductive load at

$V_{CE} =$	400	V
$V_{GE} =$	±15	V
$R_{gon} =$	16	Ω

figure 26.

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Typical switching times as a function of gate resistor
 $t = f(R_g)$



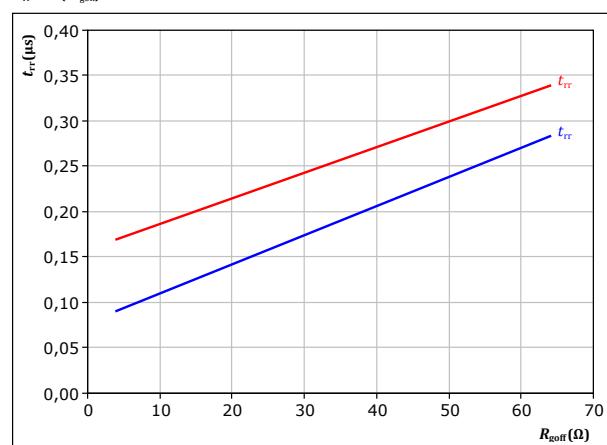
With an inductive load at

$T_j =$	125	°C
$V_{CE} =$	400	V
$V_{GE} =$	±15	V
$I_C =$	15	A

figure 28.

FWD

Typical reverse recovery time as a function of IGBT turn off gate resistor
 $t_{rr} = f(R_{goff})$



With an inductive load at

$V_{CE} =$	400	V
$V_{GE} =$	±15	V
$I_C =$	15	A



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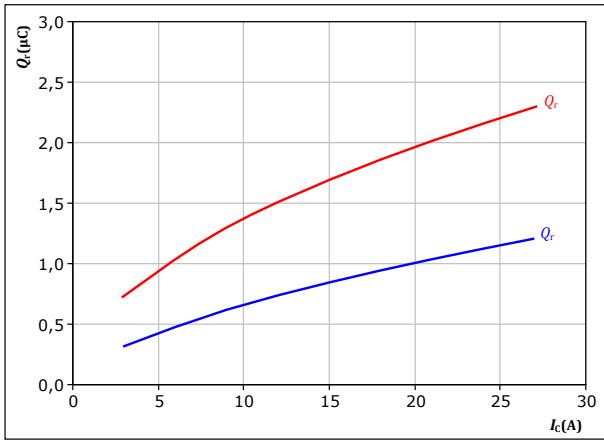
Inverter Switching Characteristics

figure 29.

FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 400 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ R_{gon} &= 16 \quad \Omega \end{aligned}$$

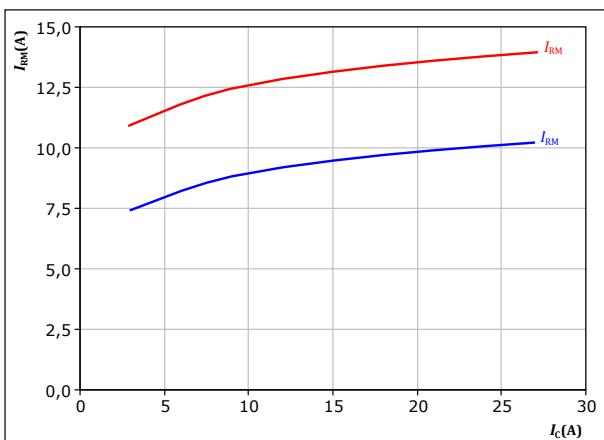
$$T_f: \quad \begin{array}{l} \text{---} \quad 25^\circ\text{C} \\ \text{---} \quad 125^\circ\text{C} \end{array}$$

figure 31.

FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 400 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ R_{gon} &= 16 \quad \Omega \end{aligned}$$

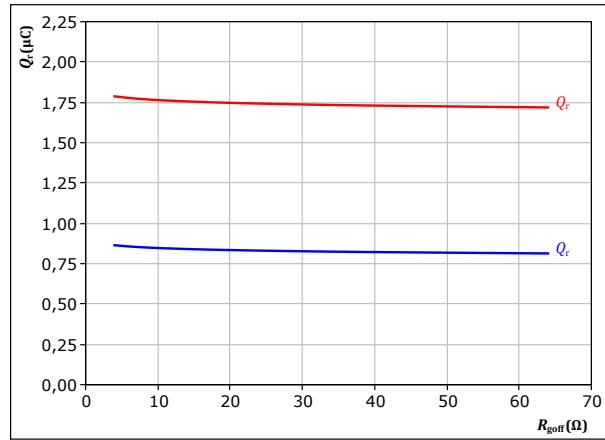
$$T_f: \quad \begin{array}{l} \text{---} \quad 25^\circ\text{C} \\ \text{---} \quad 125^\circ\text{C} \end{array}$$

figure 30.

FWD

Typical recovered charge as a function of turn off gate resistor

$$Q_r = f(R_{goff})$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 400 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ I_c &= 15 \quad \text{A} \end{aligned}$$

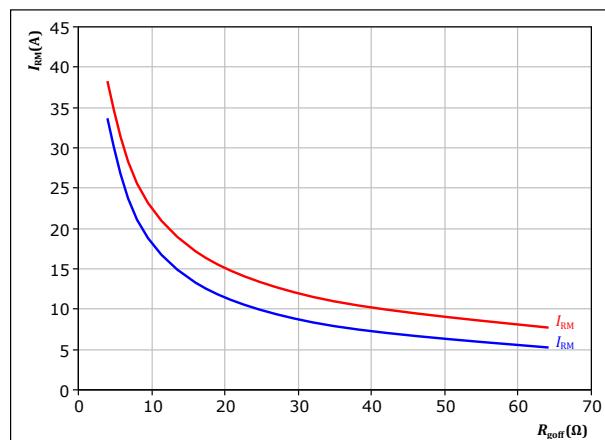
$$T_f: \quad \begin{array}{l} \text{---} \quad 25^\circ\text{C} \\ \text{---} \quad 125^\circ\text{C} \end{array}$$

figure 32.

FWD

Typical peak reverse recovery current as a function of turn off gate resistor

$$I_{RM} = f(R_{goff})$$



With an inductive load at

$$\begin{aligned} V_{CE} &= 400 \quad \text{V} \\ V_{GE} &= \pm 15 \quad \text{V} \\ I_c &= 15 \quad \text{A} \end{aligned}$$

$$T_f: \quad \begin{array}{l} \text{---} \quad 25^\circ\text{C} \\ \text{---} \quad 125^\circ\text{C} \end{array}$$

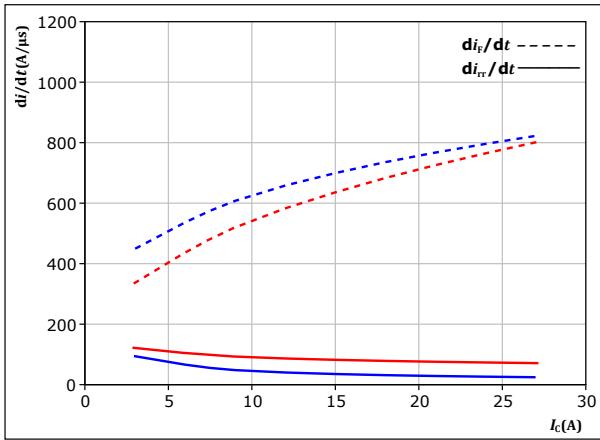


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Inverter Switching Characteristics

figure 33. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_{rr}/dt = f(I_c)$

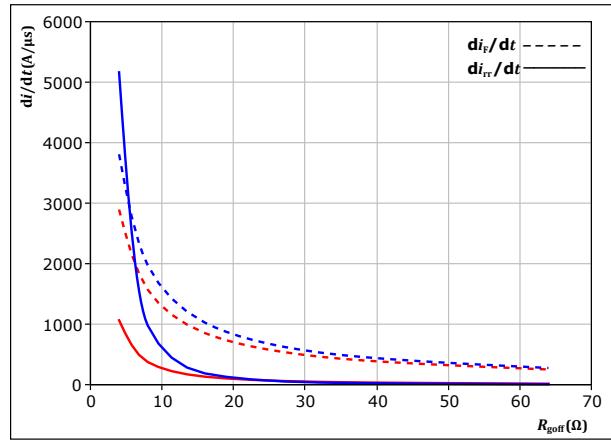


With an inductive load at

$V_{CE} = 400$ V $T_j = 25^\circ\text{C}$
 $V_{GE} = \pm 15$ V $T_j = 125^\circ\text{C}$
 $R_{gon} = 16$ Ω

figure 34. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn off gate resistor
 $di_f/dt, di_{rr}/dt = f(R_{goff})$



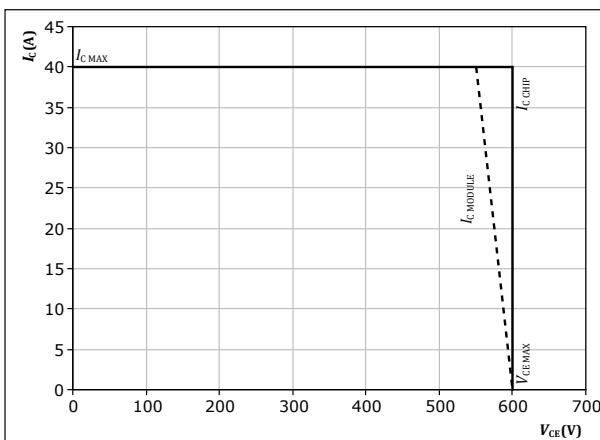
With an inductive load at

$V_{CE} = 400$ V $T_j = 25^\circ\text{C}$
 $V_{GE} = \pm 15$ V $T_j = 125^\circ\text{C}$
 $I_c = 15$ A

figure 35. IGBT

Reverse bias safe operating area

$I_c = f(V_{CE})$



At $T_j = 125^\circ\text{C}$
 $R_{gon} = 16$ Ω
 $R_{goff} = 16$ Ω



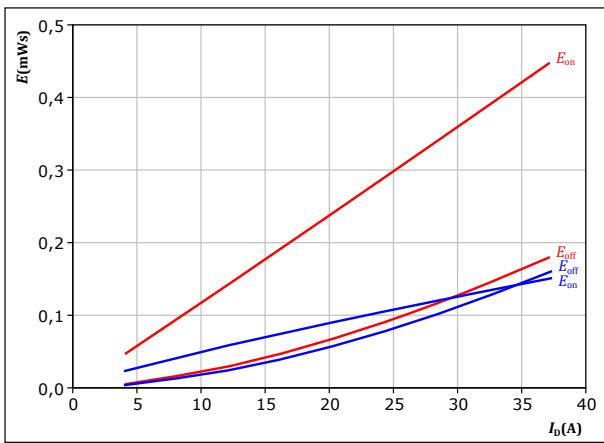
Vincotech

PFC Switching Characteristics

figure 36.

Typical switching energy losses as a function of drain current

$$E = f(I_D)$$



With an inductive load at

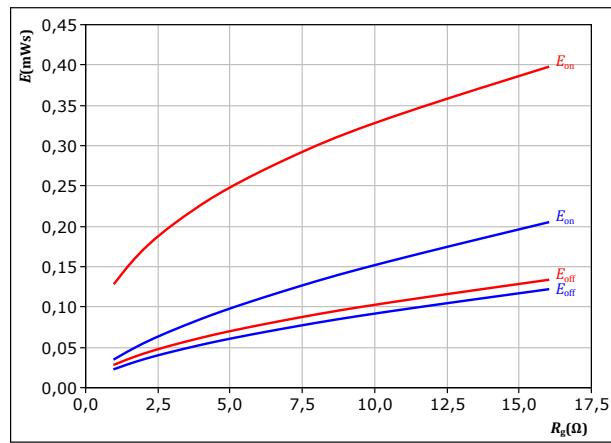
$$\begin{aligned} V_{DS} &= 400 \quad \text{V} \\ V_{GS} &= 0/10 \quad \text{V} \\ R_{gon} &= 4 \quad \Omega \\ R_{goff} &= 4 \quad \Omega \end{aligned}$$

MOSFET

figure 37.

Typical switching energy losses as a function of gate resistor

$$E = f(R_g)$$



With an inductive load at

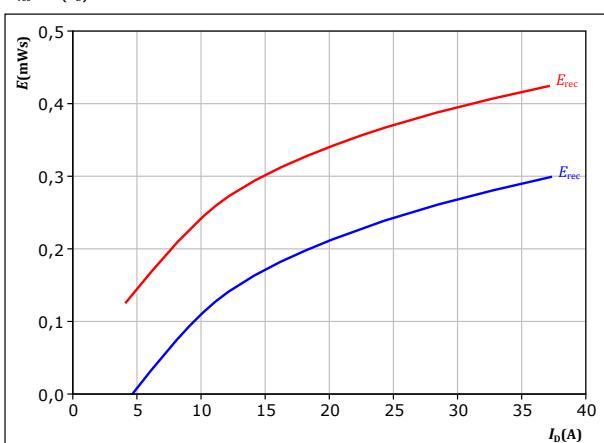
$$\begin{aligned} V_{DS} &= 400 \quad \text{V} \\ V_{GS} &= 0/10 \quad \text{V} \\ I_D &= 20 \quad \text{A} \end{aligned}$$

MOSFET

figure 38.

Typical reverse recovered energy loss as a function of drain current

$$E_{rec} = f(I_D)$$



With an inductive load at

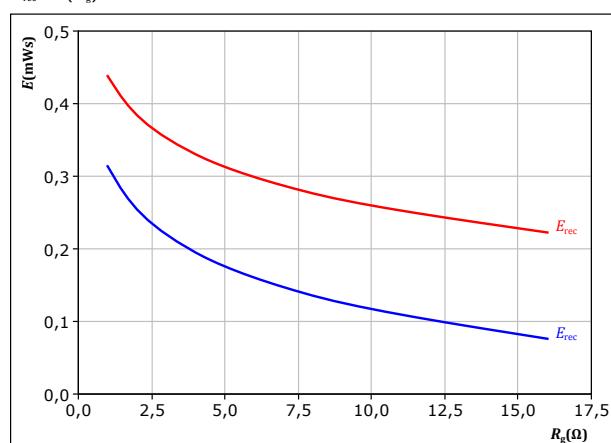
$$\begin{aligned} V_{DS} &= 400 \quad \text{V} \\ V_{GS} &= 0/10 \quad \text{V} \\ R_{gon} &= 4 \quad \Omega \end{aligned}$$

FWD

figure 39.

Typical reverse recovered energy loss as a function of gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$$\begin{aligned} V_{DS} &= 400 \quad \text{V} \\ V_{GS} &= 0/10 \quad \text{V} \\ I_D &= 20 \quad \text{A} \end{aligned}$$

FWD

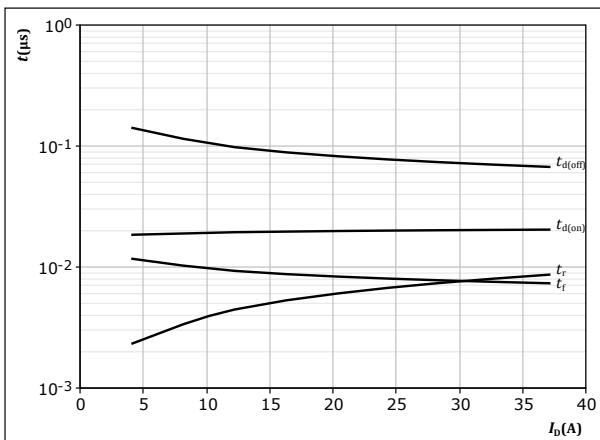


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PFC Switching Characteristics

figure 40.

Typical switching times as a function of drain current
 $t = f(I_D)$



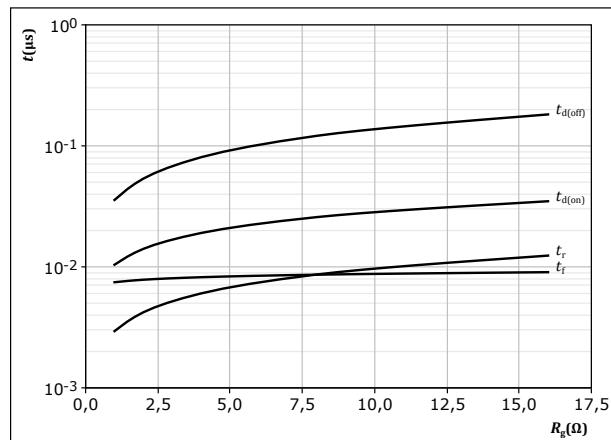
With an inductive load at

$T_j = 125^\circ\text{C}$
 $V_{DS} = 400 \text{ V}$
 $V_{GS} = 0/10 \text{ V}$
 $R_{gon} = 4 \Omega$
 $R_{goff} = 4 \Omega$

MOSFET

figure 41.

Typical switching times as a function of gate resistor
 $t = f(R_g)$



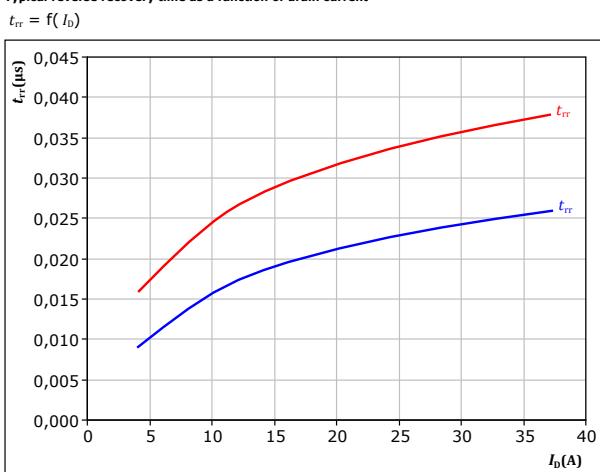
With an inductive load at

$T_j = 125^\circ\text{C}$
 $V_{DS} = 400 \text{ V}$
 $V_{GS} = 0/10 \text{ V}$
 $I_D = 20 \text{ A}$

MOSFET

figure 42.

Typical reverse recovery time as a function of drain current
 $t_{rr} = f(I_D)$

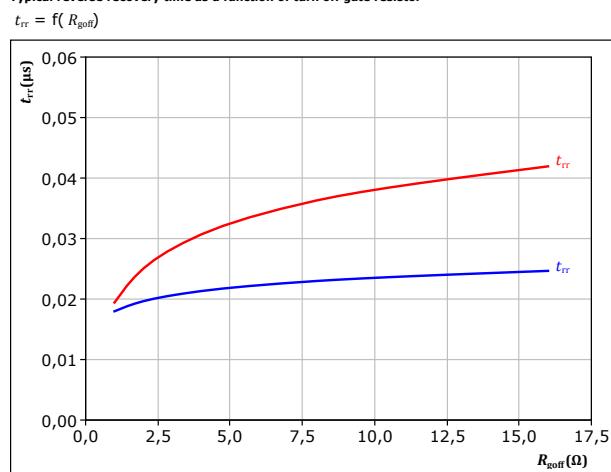


At $V_{DS} = 400 \text{ V}$
 $V_{GS} = 0/10 \text{ V}$
 $R_{gon} = 4 \Omega$

FWD

figure 43.

Typical reverse recovery time as a function of turn off gate resistor
 $t_{rr} = f(R_{goff})$



At $V_{DS} = 400 \text{ V}$
 $V_{GS} = 0/10 \text{ V}$
 $I_D = 20 \text{ A}$

$T_j = 25^\circ\text{C}$
 $T_j = 125^\circ\text{C}$



Vincotech

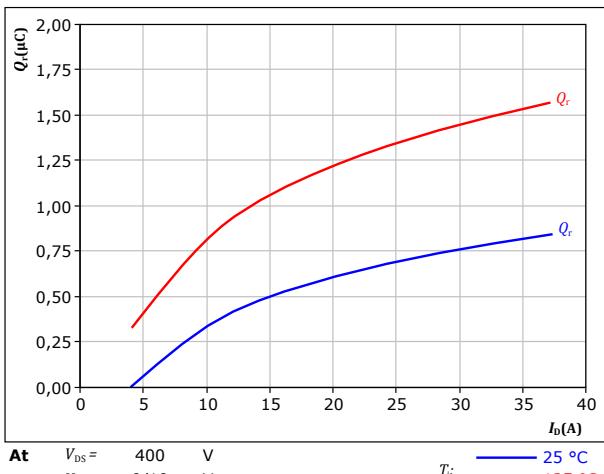
PFC Switching Characteristics

figure 44.

FWD

Typical recovered charge as a function of drain current

$$Q_r = f(I_D)$$

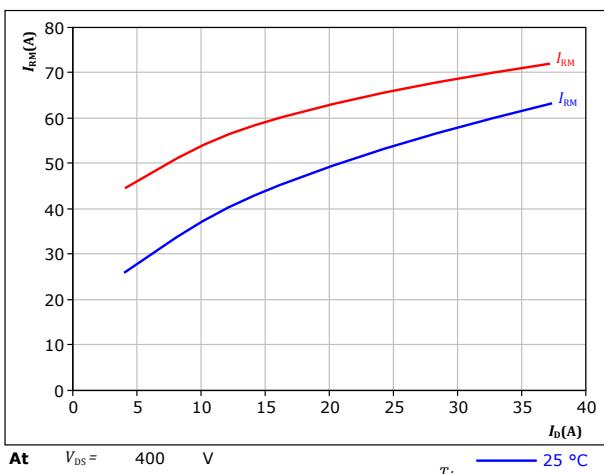


At $V_{DS} = 400$ V
 $V_{GS} = 0/10$ V
 $R_{gon} = 4 \Omega$

FWD

Typical peak reverse recovery current as a function of drain current

$$I_{RM} = f(I_D)$$



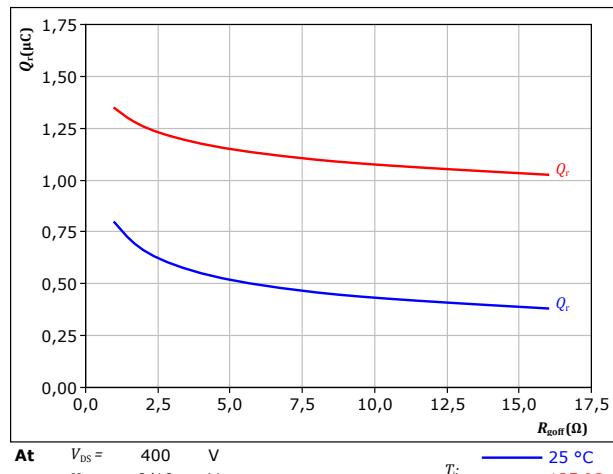
At $V_{DS} = 400$ V
 $V_{GS} = 0/10$ V
 $R_{gon} = 4 \Omega$

figure 45.

FWD

Typical recovered charge as a function of turn off gate resistor

$$Q_r = f(R_{goff})$$

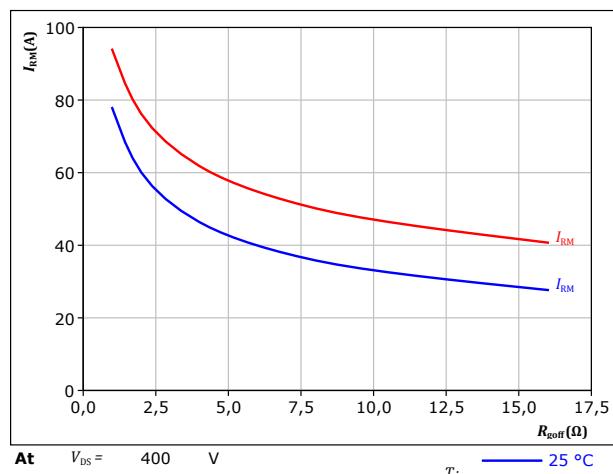


At $V_{DS} = 400$ V
 $V_{GS} = 0/10$ V
 $I_D = 20$ A

FWD

Typical peak reverse recovery current as a function of turn off gate resistor

$$I_{RM} = f(R_{goff})$$



At $V_{DS} = 400$ V
 $V_{GS} = 0/10$ V
 $I_D = 20$ A



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PFC Switching Characteristics

figure 48. FWD

Typical rate of fall of forward and reverse recovery current as a function of drain current
 $di_f/dt, di_{rr}/dt = f(I_D)$

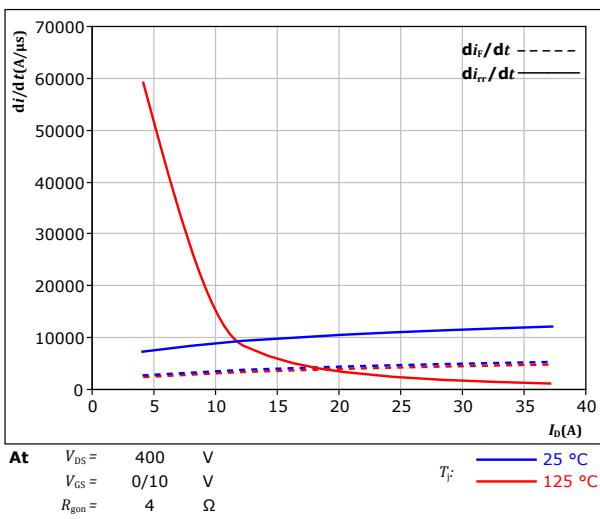


figure 49. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn off gate resistor
 $di_f/dt, di_{rr}/dt = f(R_{goff})$

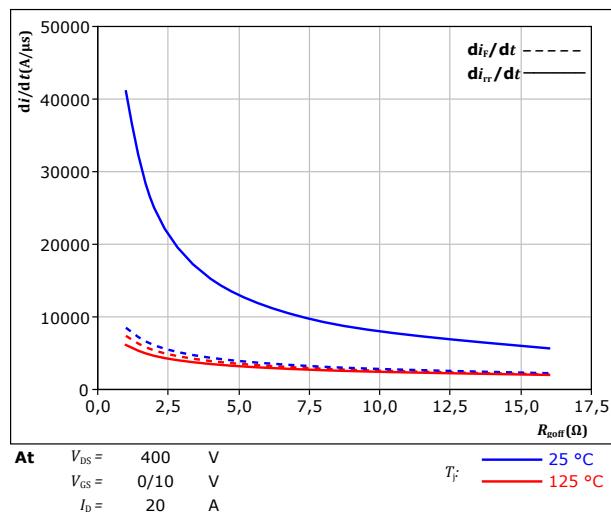
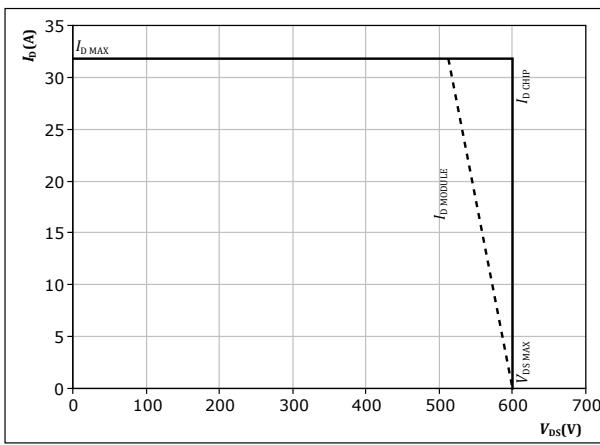


figure 50. MOSFET

Reverse bias safe operating area

$$I_D = f(V_{DS})$$





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Inverter Switching Definitions

figure 51. IGBT

Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})

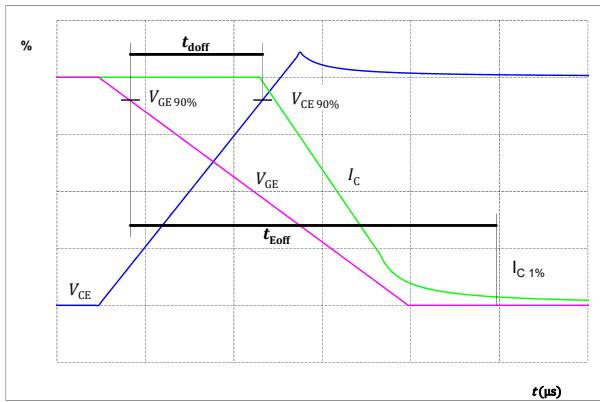


figure 52. IGBT

Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})

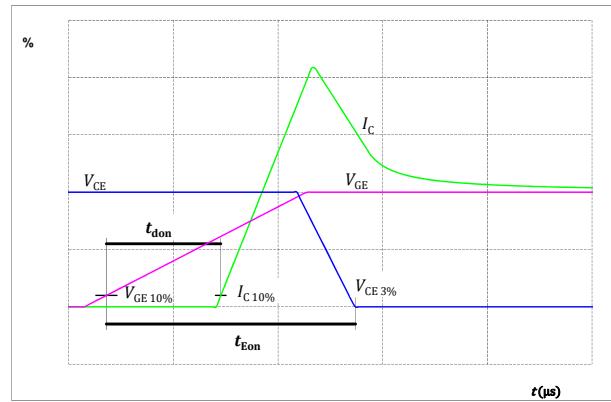


figure 53. IGBT

Turn-off Switching Waveforms & definition of t_f

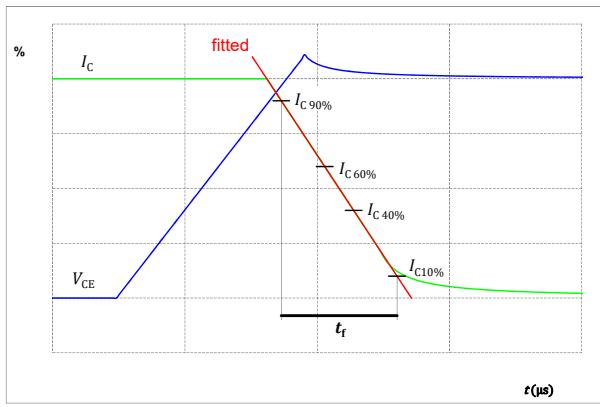
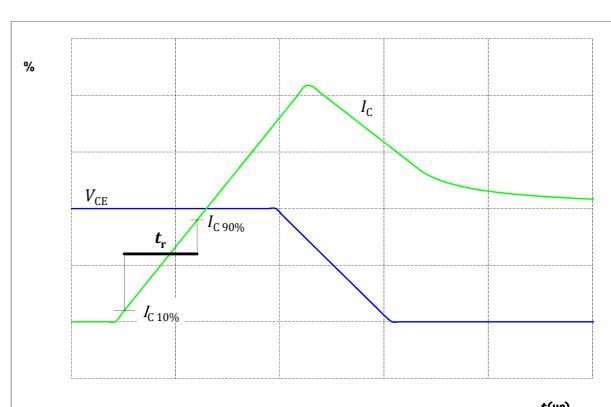


figure 54. IGBT

Turn-on Switching Waveforms & definition of t_r





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Inverter Switching Definitions

figure 55.

Turn-off Switching Waveforms & definition of t_{tr}

FWD

Copyright Vincotech

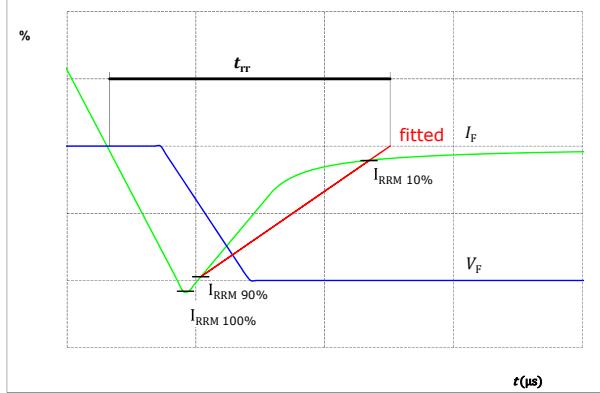
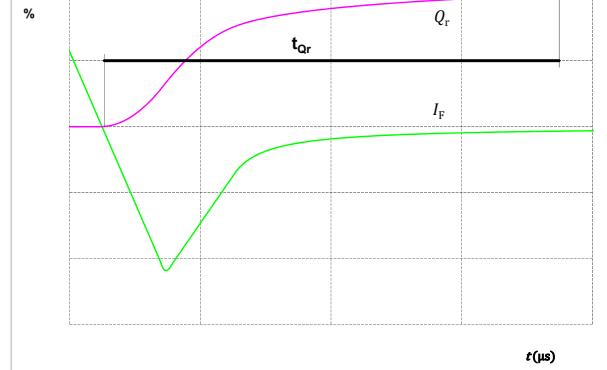


figure 56.

Turn-on Switching Waveforms & definition of t_{qr} (t_{qr} = integrating time for Q_r)

FWD

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PFC Switching Definitions

figure 51. **MOSFET**

Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})

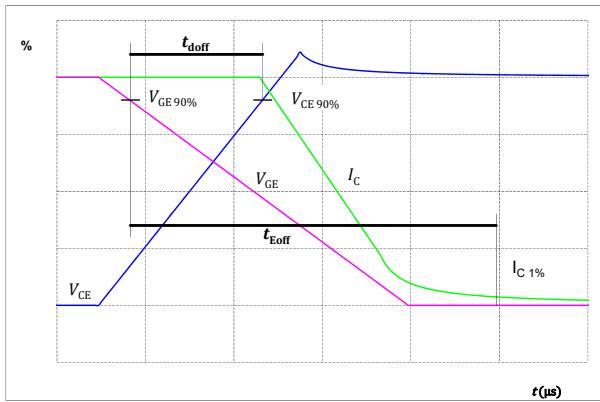


figure 52. **MOSFET**

Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})

figure 52. **MOSFET**

Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})

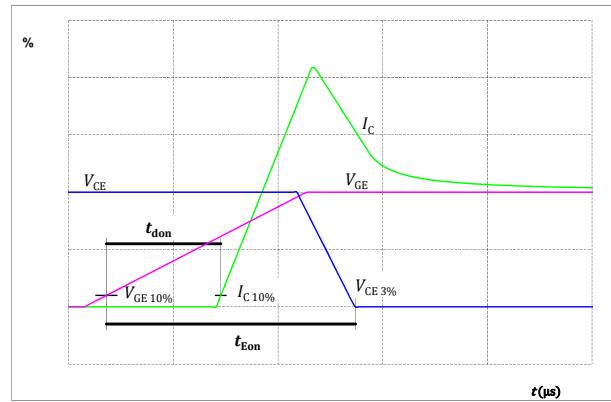


figure 53. **MOSFET**

Turn-off Switching Waveforms & definition of t_f

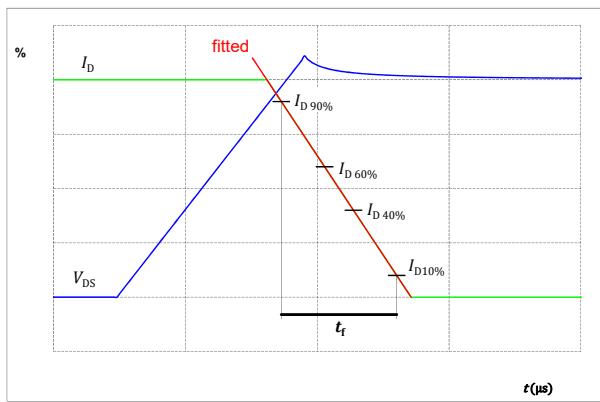
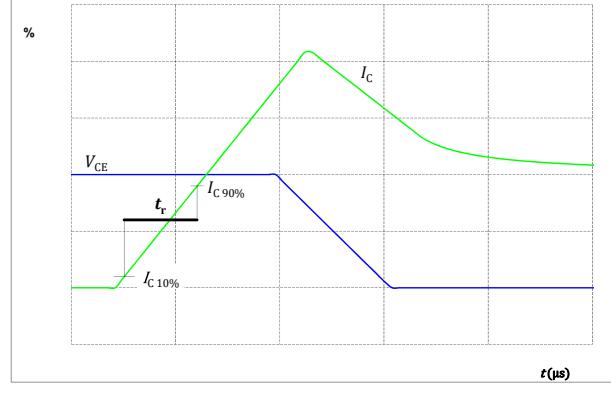


figure 54. **MOSFET**

Turn-on Switching Waveforms & definition of t_r





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PFC Switching Definitions

figure 55.

Turn-off Switching Waveforms & definition of t_{tr}

FWD

Turn-off Switching Waveforms & definition of t_{tr}

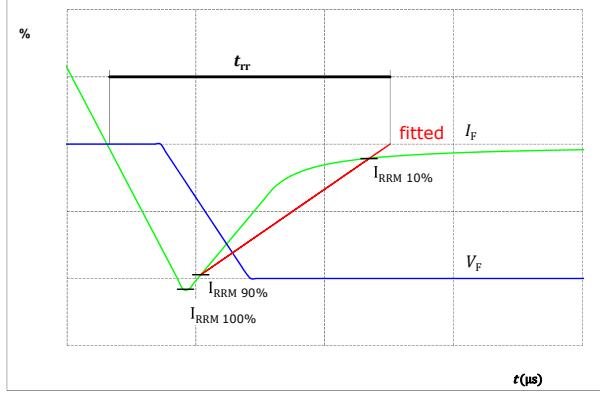


figure 56.

Turn-on Switching Waveforms & definition of t_{Qtr} (t_{Qtr} = integrating time for Q_{tr})

FWD

Turn-on Switching Waveforms & definition of t_{Qtr} (t_{Qtr} = integrating time for Q_{tr})

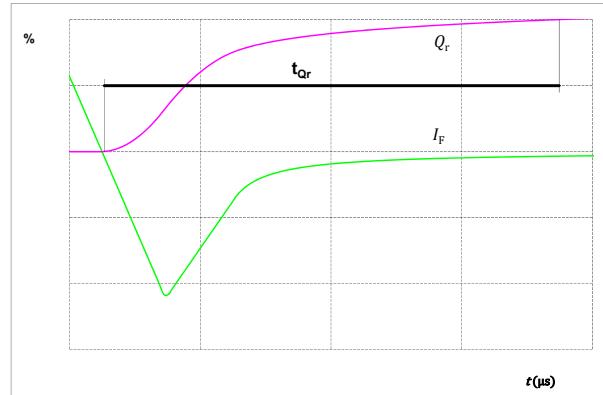
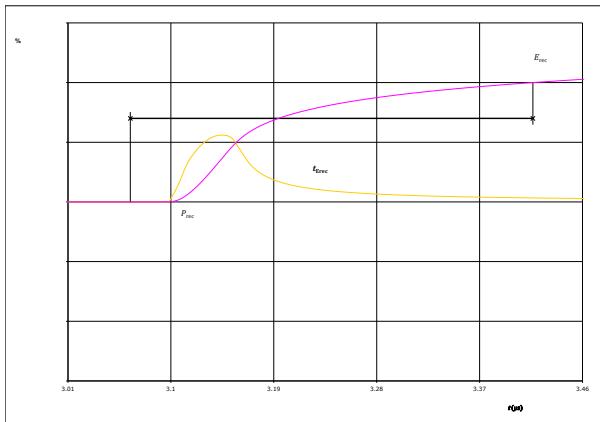


figure 57.

Turn-on Switching Waveforms & definition of t_{Erec} (t_{Erec} = integrating time for E_{rec})

FWD

Turn-on Switching Waveforms & definition of t_{Erec} (t_{Erec} = integrating time for E_{rec})



**10-F006PPA020SB03-M685B09**

datasheet

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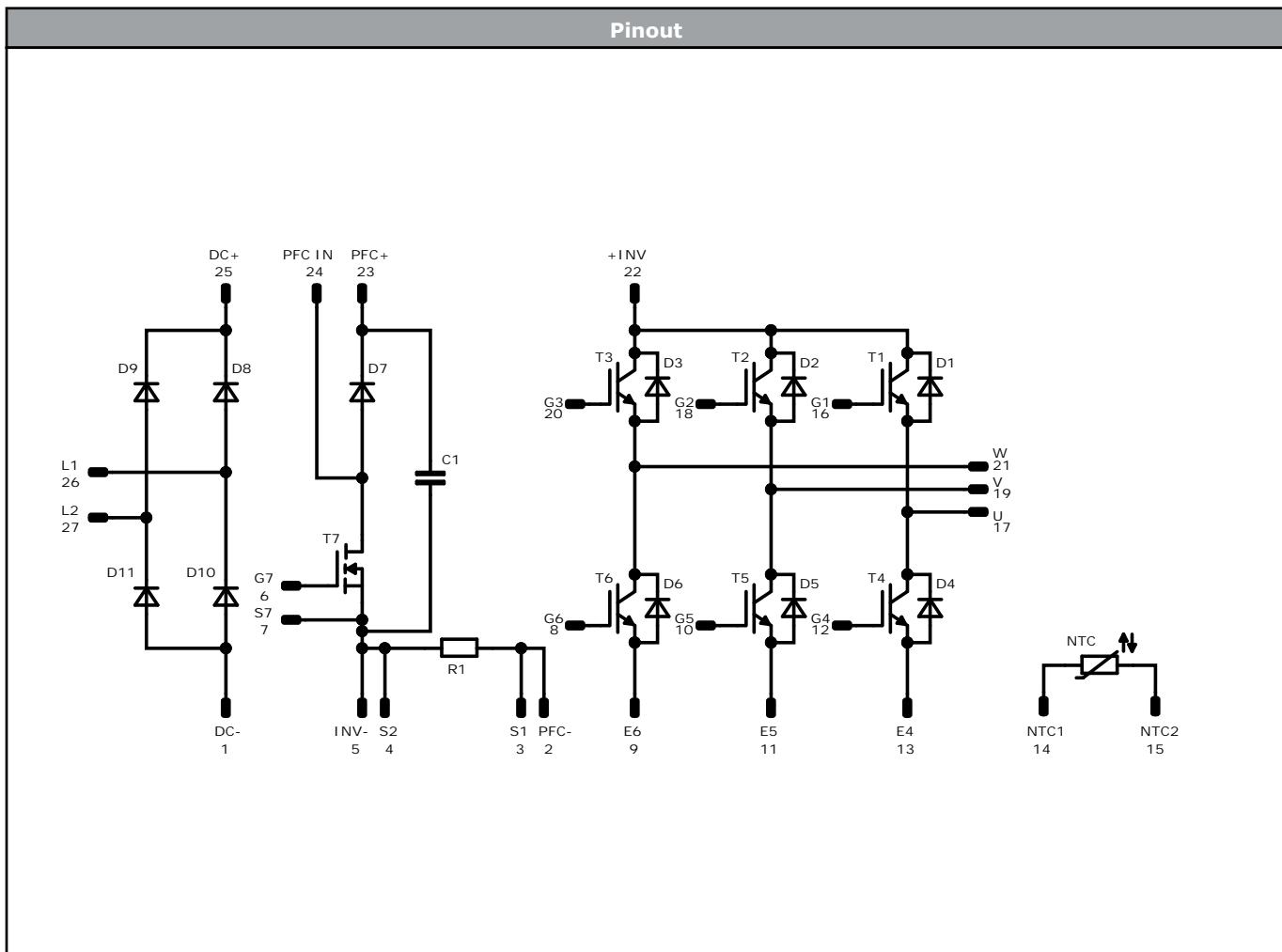
Ordering Code						
Version				Ordering Code		
Without thermal paste				10-F006PPA020SB03-M685B09		
With thermal paste (5,2 W/mK, PTM6000HV)				10-F006PPA020SB03-M685B09-/7/		
With thermal paste (3,4 W/mK, PSX-P7)				10-F006PPA020SB03-M685B09-/3/		

Marking						
Text	Name		Date code	UL & VIN	Lot	Serial
	NN-NNNNNNNNNNNNNN	TTTTTTVV	WWYY	UL VIN	LLLLL	SSSS
Datamatrix	Type&Ver	Lot number	Serial	Date code		
	TTTTTTVV	LLLLL	SSSS	WWYY		

Outline																																																																																																																						
<table border="1"><caption>Pin table [mm]</caption><thead><tr><th>Pin</th><th>X</th><th>Y</th><th>Function</th></tr></thead><tbody><tr><td>1</td><td>33,5</td><td>0</td><td>DC-</td></tr><tr><td>2</td><td>30,7</td><td>0</td><td>PFC-</td></tr><tr><td>3</td><td>28</td><td>0</td><td>S1</td></tr><tr><td>4</td><td>25,3</td><td>0</td><td>S2</td></tr><tr><td>5</td><td>22,6</td><td>0</td><td>INV-</td></tr><tr><td>6</td><td>19,9</td><td>0</td><td>G7</td></tr><tr><td>7</td><td>17,2</td><td>0</td><td>S7</td></tr><tr><td>8</td><td>13,5</td><td>0</td><td>G6</td></tr><tr><td>9</td><td>10,8</td><td>0</td><td>E6</td></tr><tr><td>10</td><td>8,1</td><td>0</td><td>G5</td></tr><tr><td>11</td><td>5,4</td><td>0</td><td>E5</td></tr><tr><td>12</td><td>2,7</td><td>0</td><td>G4</td></tr><tr><td>13</td><td>0</td><td>0</td><td>E4</td></tr><tr><td>14</td><td>0</td><td>8,6</td><td>NTC1</td></tr><tr><td>15</td><td>0</td><td>11,45</td><td>NTC2</td></tr><tr><td>16</td><td>0</td><td>19,8</td><td>G1</td></tr><tr><td>17</td><td>0</td><td>22,5</td><td>U</td></tr><tr><td>18</td><td>6</td><td>19,8</td><td>G2</td></tr><tr><td>19</td><td>6</td><td>22,5</td><td>V</td></tr><tr><td>20</td><td>12</td><td>19,8</td><td>G3</td></tr><tr><td>21</td><td>12</td><td>22,5</td><td>W</td></tr><tr><td>22</td><td>17,7</td><td>22,5</td><td>+INV</td></tr><tr><td>23</td><td>20,5</td><td>22,5</td><td>PFC+</td></tr><tr><td>24</td><td>26,5</td><td>22,5</td><td>PFC IN</td></tr><tr><td>25</td><td>33,5</td><td>22,5</td><td>DC+</td></tr><tr><td>26</td><td>33,5</td><td>15</td><td>L1</td></tr><tr><td>27</td><td>33,5</td><td>7,5</td><td>L2</td></tr></tbody></table>	Pin	X	Y	Function	1	33,5	0	DC-	2	30,7	0	PFC-	3	28	0	S1	4	25,3	0	S2	5	22,6	0	INV-	6	19,9	0	G7	7	17,2	0	S7	8	13,5	0	G6	9	10,8	0	E6	10	8,1	0	G5	11	5,4	0	E5	12	2,7	0	G4	13	0	0	E4	14	0	8,6	NTC1	15	0	11,45	NTC2	16	0	19,8	G1	17	0	22,5	U	18	6	19,8	G2	19	6	22,5	V	20	12	19,8	G3	21	12	22,5	W	22	17,7	22,5	+INV	23	20,5	22,5	PFC+	24	26,5	22,5	PFC IN	25	33,5	22,5	DC+	26	33,5	15	L1	27	33,5	7,5	L2						
Pin	X	Y	Function																																																																																																																			
1	33,5	0	DC-																																																																																																																			
2	30,7	0	PFC-																																																																																																																			
3	28	0	S1																																																																																																																			
4	25,3	0	S2																																																																																																																			
5	22,6	0	INV-																																																																																																																			
6	19,9	0	G7																																																																																																																			
7	17,2	0	S7																																																																																																																			
8	13,5	0	G6																																																																																																																			
9	10,8	0	E6																																																																																																																			
10	8,1	0	G5																																																																																																																			
11	5,4	0	E5																																																																																																																			
12	2,7	0	G4																																																																																																																			
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14	0	8,6	NTC1																																																																																																																			
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22	17,7	22,5	+INV																																																																																																																			
23	20,5	22,5	PFC+																																																																																																																			
24	26,5	22,5	PFC IN																																																																																																																			
25	33,5	22,5	DC+																																																																																																																			
26	33,5	15	L1																																																																																																																			
27	33,5	7,5	L2																																																																																																																			
						Tolerance of pinpositions ±0,5mm at the end of pins Dimension of coordinate axis is only offset without tolerance																																																																																																																



Vincotech



Identification

ID	Component	Voltage	Current	Function	Comment
T6, T3, T5, T2, T4, T1	IGBT	600 V	20 A	Inverter Switch	
D3, D6, D2, D5, D1, D4	FWD	600 V	30 A	Inverter Diode	
T7	MOSFET	600 V	49 mΩ	PFC Switch	
D7	FWD	600 V	30 A	PFC Diode	
D11, D9, D10, D8	Rectifier	1600 V	18 A	Rectifier Diode	
R1	Shunt			PFC Shunt	
C1	Capacitor	500 V		Capacitor (PFC)	
NTC	NTC			Thermistor	

**10-F006PPA020SB03-M685B09**

datasheet

Vincotech**Packaging instruction**

Standard packaging quantity (SPQ) 135	>SPQ	Standard	<SPQ	Sample
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Handling instruction

Handling instructions for flow 0 packages see vincotech.com website.

Package data

Package data for flow 0 packages see vincotech.com website.

Vincotech thermistor reference

See Vincotech thermistor reference table at vincotech.com website.

UL recognition and file number

This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.



Document No.:	Date:	Modification:	Pages
10-F006PPA020SB03-M685B09-D1-14	7 Jan. 2022		

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.